650V, 70A, $V_{CE(on)}$ = 1.9V Typical

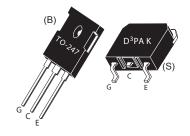
Ultra Fast NPT - IGBT®

The Ultra Fast 650V NPT-IGBT® family of products is the newest generation of IGBTs optimized for outstanding ruggedness and best trade-off between conduction and switching losses.

Features

- · Low Saturation Voltage
- Low Tail Current
- RoHS Compliant

- · Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current





Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

MAXIMUM RATINGS

All Ratings:	_C =	25°C	unless	otherwise	specified.

Symbol	Parameter	Ratings	Unit
V _{ces}	Collector Emitter Voltage	650	V
V_{GE}	Gate-Emitter Voltage	±30	V
I _{C1}	Continuous Collector Current @ T _c = 25°C	134	
I _{C2}	Continuous Collector Current @ T _c = 110°C	65	Α
I _{CM}	Pulsed Collector Current ①	260	
SCWT	Short Circuit Withstand Time: V _{CE} = 600V, V _{GE} = 15V, T _C =125°C	10	μs
P _D	Total Power Dissipation @ T _c = 25°C	595	W
T_{J},T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	ာ့
T_{L}	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	C

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage (V _{GE} = 0V, I _C = 250uA)	650			
V _{GE(TH)}	Gate Threshold Voltage $(V_{CE} = V_{GE}, I_{C} = 1.0 \text{mA}, T_{j} = 25 ^{\circ}\text{C})$	3.5	5.0	6.5	l ,, ,,
V _{CE(ON)}	Collector-Emitter On Voltage $(V_{GE} = 15V, I_C = 70A, T_j = 25^{\circ}C)$	ĺ	1.9	2.4	Volts
	Collector-Emitter On Voltage (V _{GE} = 15V, I _C = 70A, T _j = 125°C)		2.4		
	Collector-Emitter On Voltage (V _{GE} = 15V, I _C = 140A, T _j = 25°C)		2.6		
I _{ces}	Collector Cut-off Current (V _{CE} = 650V, V _{GE} = 0V, T _j = 25°C) ②		10	250	μA
OE3	Collector Cut-off Current (V _{CE} = 650V, V _{GE} = 0V, T _j = 125°C) ②		100		
I _{GES}	Gate-Emitter Leakage Current (V _{GE} = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

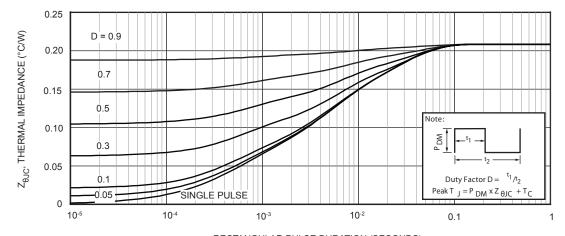
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C _{ies}	Input Capacitance	Capacitance		4250		
C _{oes}	Output Capacitance	$V_{GE} = 0V, V_{CE} = 25V$		847		pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz		415	ĺ	
V_{GEP}	Gate to Emitter Plateau Voltage	Gate Charge		7.0		V
Q _g 3	Total Gate Charge	V _{GE} = 15V		226	305	
Q_{ge}	Gate-Emitter Charge	V _{CE} = 325V		26	35	nC
Q_{gc}	Gate- Collector Charge	I _C = 70A		104	140	
t _{d(on)}	Turn-On Delay Time	Inductive Switching (25°C)	ĺ	19		
t _r	Current Rise Time	V _{cc} = 433V		45		ne
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		170		ns
t _f	Current Fall Time	I _C = 70A		67		
E _{on2} ⑤	Turn-On Switching Energy	$R_{G} = 4.3\Omega^{\textcircled{4}}$		1505	2260	1
E _{off}	Turn-Off Switching Energy	T _J = +25°C		1460	1970	μJ
t _{d(on)}	Turn-On Delay Time	Inductive Switching (125°C)	ĺ	19		
t,	Current Rise Time	V _{cc} = 433V		45		
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		190		ns
t _r	Current Fall Time	I _C = 70A		74		
E _{on2} ⁽⁵⁾	Turn-On Switching Energy	$R_{_{\rm G}} = 4.3\Omega^{(4)}$		1560	2340	1
E _{off}	Turn-Off Switching Energy	T ₁ = +125°C		1720	2580	μJ

THERMAL AND MECHANICAL CHARACTERISTICS

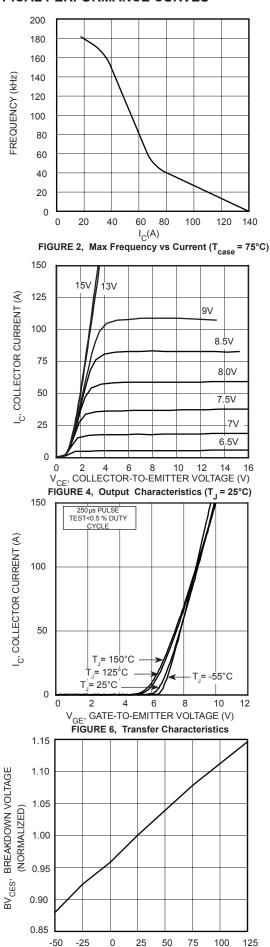
Symbol	Characteristic	Min	Тур	Max	Unit
$R_{\theta JC}$	Junction to Case Thermal Resistance			.21	°C/W
$R_{_{\theta JA}}$	Junction to Ambient Thermal Resistance			40	
W _T Pa	Package Weight		.22		oz
			6.2		g
Torque	Mounting Torque (TO-247 Package), 4-40 or M3 screw			10	in-lbf
				6.2	N·m

- 1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.
- 2 Pulse test: Pulse Width < $380\mu s$, duty cycle < 2%.
- 3 See Mil-Std-750 Method 3471.
- 4 R_a is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)
- 5 E_{on2} is the energy loss at turn-on and includes the charge stored in the freewheeling diode.

 $^{\circ}$ Use the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1. Microsemi reserves the right to change, without notice, the specifications and information contained herein.

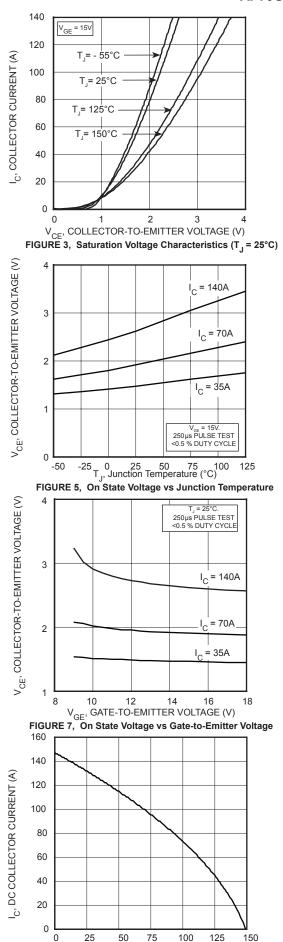


RECTANGULAR PULSE DURATION (SECONDS)
Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration



 $T_{\rm J}$, JUNCTION TEMPERATURE

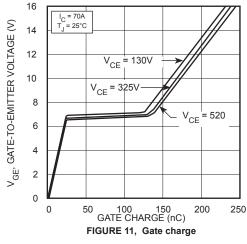
FIGURE 8, Breakdown Voltage vs Junction Temperature

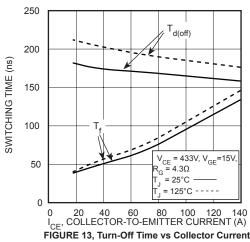


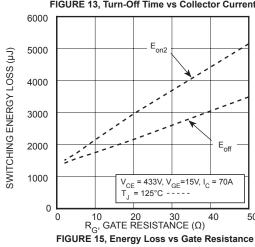
T_C, Case Temperature (°C)

FIGURE 9, DC Collector Current vs Case Temperature

FIGURE 16, Swiitching Energy vs Junction Temperature







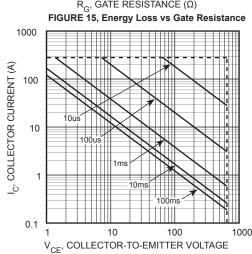
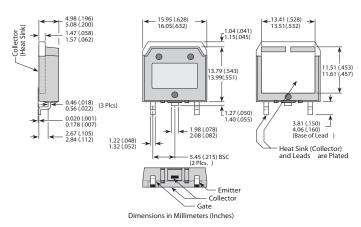


FIGURE 17, Minimum Switching Safe Operating Area

TO-247 Package Outline

4.69 (.185) 5.31 (.209) 1.49 (.059) 2.49 (.098) 5.38 (.212) 6.20 (.244) 6.15 (.242) BSC 20.80 (.819) 21.46 (.845) Collector 4.50 (.177) Max. 1.65 (.065) 2.13 (.084) 0.40 (.016) 0.79 (.031) 1.01 (.040) 1.40 (.055) Collector Emitter 5.45 (.215) BSC 2-Plcs. Dimensions in Millimeters and (Inches)

D³PAK Package Outline e3 : 100% Sn Plating



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